SCOPE:

This specification applies to the Pb Free high current type SMD inductors for

MSI-120909M-SERIES-□

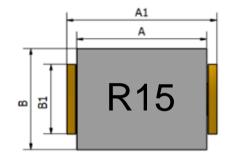
Warn: This product series can't be used in synchronous rectification circuit that is over 24V

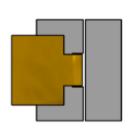
PRODUCT INDENTIFICATION

MSI-120909M-R15 M -E-□□

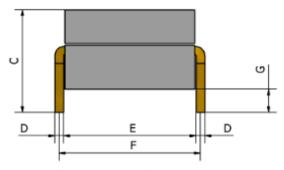
- 1) (
- 3 4 5
- **1** Product Code
- 2 Dimensions Code
- ③ Inductance Code
- Tolerance Code
- **⑤ Inner Control Code**

(1) SHAPES AND DIMENSIONS (mm)





A:	10.8	Max.
A 1:	12.1	Max.
B:	9.1	Max.
B1:	6.3	Max.
C:	9.1	Max.
D:	0.50	Тур.
E:	10.70	Тур.
F:	11.20	Тур.
G:	2.00	Тур.



(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

L: HP 4284A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

IDC1 :WK3255B+3265B (or equivalent)

(3) CHARACTERISTICS

(3)-1 Operate temperature range $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$ (Including self temp. rise)

(3)-2 Storage temperature range -40° C $\sim +125^{\circ}$ C



TABLE

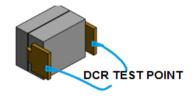
MAGLAYERS	Inductance	Percent	L Test	Resistance	Rated DC Current		Marking
PT/NO.	L(µH)	Tolerance	Frequency	RDC(mΩ)	Isat(A)	Irms(A)	Warking
MSI-120909M-R125∐-E	0.125	L,M	100KHz/0.1V	0.28±10%	95	45	R125
MSI-120909M-R15∐-E	0.150	М	100KHz/0.1V	0.28±10%	80	45	R15
MSI-120909M-R18∐-E	0.180	М	100KHz/0.1V	0.28±10%	67	45	R18
MSI-120909M-R23∐-E	0.230	L,M	100KHz/0.1V	0.28±10%	56	45	R23
MSI-120909M-R27∐-E	0.270	М	100KHz/0.1V	0.28±10%	47	45	R27
MSI-120909M-R47∐-E	0.470	М	100KHz/0.1V	0.28±10%	23	45	R47

※ ☐ specify the inductance tolerance,L(±15%),M(±20%)

% Isat : Based on inductance change (\triangle L/Lo : drop 20% Typ.)@ ambient temp. 25 $^{\circ}$ C

Irms: Based on temperature rise ($\triangle T$: 40°C TYP.) Rated DC Current: The less value which is lsat or Irms.

RDC TEST POINT





(4) RELIABILITY TEST METHOD

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85 $^{\circ}\mathrm{C}$,and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be △L/L20°C ≦±10%.

MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS			
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		in figure 1 and a load applied unitil the figure in the arrow			
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)			
	no mechanical	PCB dimension shall the page 7/9			
	damage or elec-	F(Pressurization)			
	trical damage.	\Box			
		R5 45±2 45±2			
		10 20 R340			
		PRESSURE ROD figure-1			

MECHANICAL

TEST ITEM		SPECIFICATION				
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board				
		and when a vibration having an amplitude of 1.52mm				
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should				
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.				
	damage.	(A total of 6 hours)				
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated				
	More than 90%	over the whole of the sample before hard, the sample shall				
		then be preheated for about 2 minutes in a temperature of				
		130∼150℃ and after it has been immersed to a depth 0.5mm				
		below for 3±0.2 seconds fully in molten solder M705 with				
		a temperature of 245±5℃.				
		More than 90% of the electrode sections shall be couered				
		with new solder smoothly when the sample is taken out of the solder bath.				
Resistance to	There shall be	Temperature profile of reflow soldering				
Soldering heat	no damage or	soldering				
(reflow soldering)	problems.	© 300 — (Peak temperature 260±3℃ 10 sec)				
		Ing. 250				
		200 30 sec Min				
		(230 ⁺⁰ °C) □ 150 Pre-heating				
		Pre-heating (Peak temperature 260±3°C 10 sec) (Peak temperature 260±3°C 10 sec) (Peak temperature 260±3°C 10 sec) (Slow cooling (Stored at room)				
		i / i temperature)				
		50/				
		2 min sec. 2 min. or more				
		sec. 2 min. or more				
1						
		The specimen shall be passed through the reflow oven with the				
		condition shown in the above profile for 1 time.				
1		The specimen shall be stored at standard atmospheric conditions				
1		for 1 hour, after which the measurement shall be made.				
1						



ENVIROMENT CHARACTERISTICS

TEST ITEM				SPECIFICATION			
High temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmospere with					
storage		a temperature of 125 $^{\circ}$ C and a normal humidity.					
	There shall be	Upon completion of the measurement shall be made after the					
	no mechanical	sample has been left in a normal temperature and normal					
	damage.	humidity for 1 hour.					
Low temperature	∆L/Lo≦±5%	The san	nple sl	nall be left for 96±4 hou	ırs in an atmosphere v	with	
storage		a tempe	rature	of -40±3℃.			
	There shall be	Upon completion of the test, the measurement shall be made					
	no mechanical	after the	samp	ole has been left in a no	ormal temperature and	k	
	damage.	normal	humid	ity for 1 hour.			
Change of	∆L/Lo≦±5%	The san	nple sl	nall be subject to 5 con	tinuos cycles, such a	s shown	
temperature		in the ta	ble 2 l	below and then it shall	be subjected to stand	lard	
	There shall be	stmospheric conditions for 1 hour, after which measurement					
	no other dama-	shall be	made				
	ge of problems						
		ı		table 2		i	
				Temperature	Duration		
			1	-40±3℃	30 min.		
				(Themostat No.1)			
			2	Standard	No.1→No.2		
				atmospheric			
			3	125±2 ℃	30 min.		
				(Themostat No.2)			
			4	Standard	No.2→No.1		
				atmospheric			
Moisture storage	∆L/Lo≦±5%	The san	nple sl	nall be left for 96±4 hou	irs in a temperature o	f	
		40±2℃ and a humidity(RH) of 90∼95%.					
	There shall be	Upon completion of the test, the measurement shall be made					
	no mechanical	after the sample has been left in a normal temperature and normal humidity more than 1 hour.					
	damage.						
Test conditions :							
The sar	nple shall be reflow	soldered	d onto	the printed circuit boa	rd in every test.		

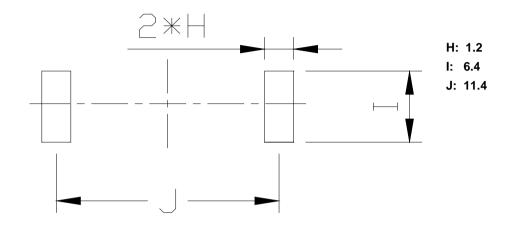


(5) LAND DIMENSION (Ref.)

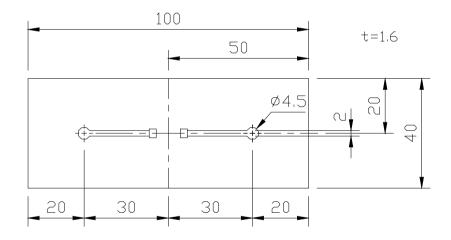
PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS(mm)

(STANDARD PATTERN)



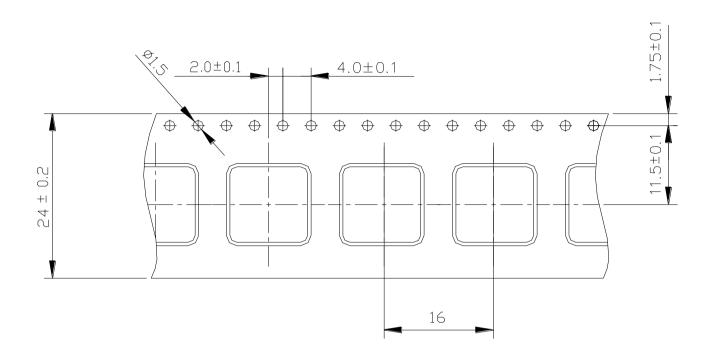
(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



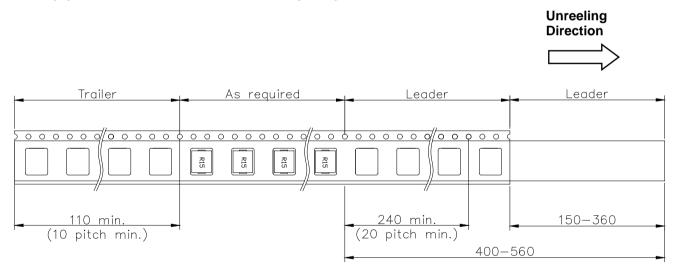


(6) PACKAGING

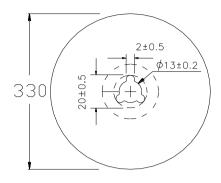
(6)-1 CARRIER TAPE DIMENSIONS (mm)

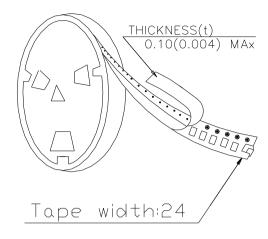


(6)-2 TAPING DIMENSIONS (mm)



(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

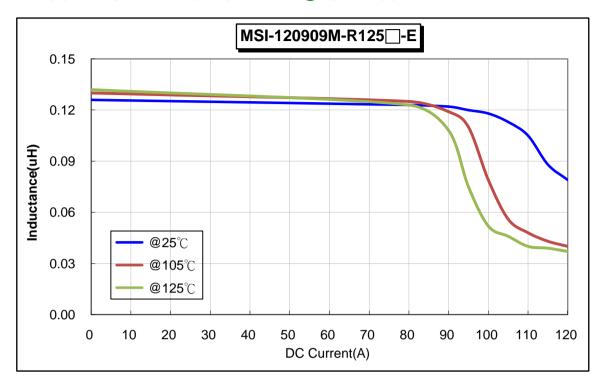
350 pcs/Reel

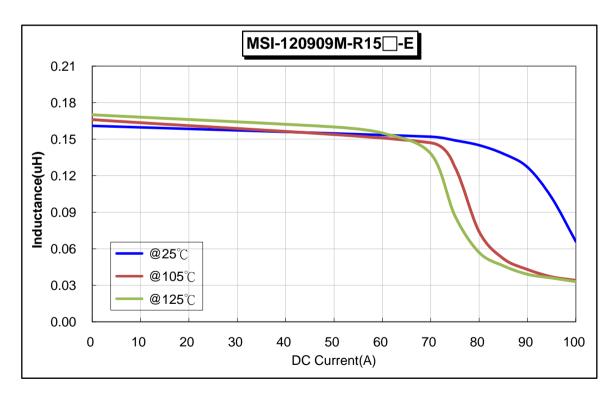
The products are packaged so that no damage will be sustained.

Please note that the contents may change without any prior notice due to reasons such as upgrading.



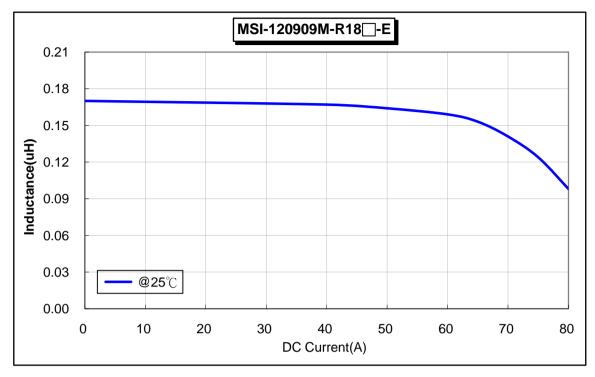
INDUCTANCE vs. DC CURRENT@100kHz/0.1V

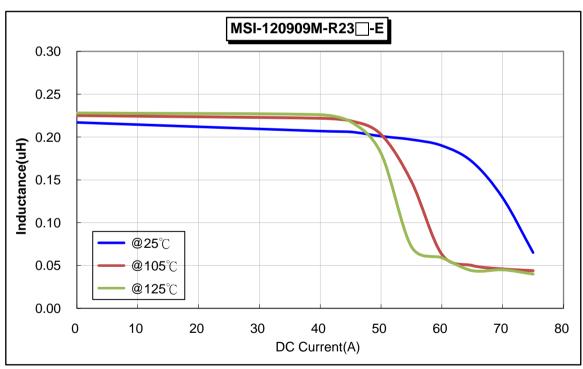






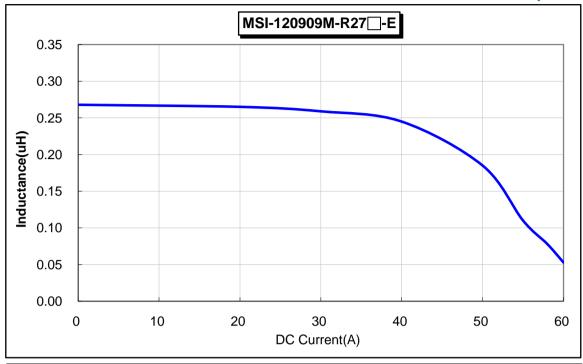
INDUCTANCE vs. DC CURRENT@100kHz/0.1V

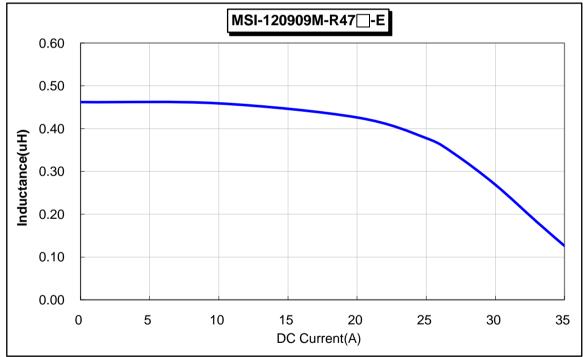






INDUCTANCE vs. DC CURRENT@100kHz/0.1V ⟨ambient temp. 25°C⟩







Temperature Rise vs. DC Current

